



# Product Change Notification

**Change Notification #:** 116631 - 00  
**Change Title:** Intel® Server Board S1200SPLR,  
Intel® Server Board S1200SPSR,  
Intel® Server Board S1200SPOR  
PCN 116631-00, Product Design,  
Update S1200SP Board Family Design  
**Date of Publication:** December 07, 2018

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material: *</b>	December 25, 2018
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\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

## Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Server Board S1200SPLR, Intel® Server Board S1200SPSR, and Intel® Server Board S1200SPOR.

Due to a MOSFET component going End of Life (EOL) by one of our vendors, a couple of changes were made to the design of the Intel® Server Board S1200SP Family. The following components were changed:

1. MOSFET U2B1 was replaced with a new part not going EOL. The MOSFET is part of P5V\_Aux switch circuit.
2. EU8J1 changed due to the original part will be End of Life soon. This IC is a 1G DDR memory used by the Baseboard Motherboard Controller (BMC). Both new components are identical in function or form factor to the previous ones, and no functionality is affected by the change.

## Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

## Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
DBS1200SPLR	951869	H77895-273	H57532-272	H77895-350	H57532-350
DBS1200SPSR	951870	H77897-273	H57533-272	H77897-350	H57533-350
DBS1200SPOR	951871	H77898-273	H57534-272	H77898-350	H57534-350

## PCN Revision History:

**Date of Revision:**  
December 7, 2018

**Revision Number:**  
00

**Reason:**  
Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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